# 3.3V / 5V ECL Differential Receiver/Driver with **Variable Output Swing and Internal Input Termination**

The MC100EP16VT is a differential receiver functionally equivalent to the 100EP16 with input pins controlling the amplitude of the outputs (pin 1) and providing an internal termination network (pin 4).

The V<sub>CTRL</sub> input pin controls the output amplitude of the EP16VT and is referenced to  $V_{CC}$ . (See Figure 4.) The operational range of the  $V_{CTRL}$  input is from  $\leq V_{BB}$  (a supply at  $V_{CC}$ -1.42 V, maximum output amplitude) to V<sub>CC</sub> (minimum output amplitude). V<sub>BB</sub> is an externally supplied voltage equal to V<sub>CC</sub>-1.42 V (See Figures 2 and 3). A variable resistor between V<sub>CC</sub> and V<sub>BB</sub>, with the wiper driving V<sub>CTRL</sub>, can control the output amplitude. Typical application circuits and a V<sub>CTRL</sub> Voltage vs. Output Amplitude graph are described in this data sheet. When left open, the V<sub>CTRL</sub> pin will be internally pulled down to V<sub>EE</sub> and operate as a standard EP16, with 100% output amplitude.

The V<sub>TT</sub> input pin offers an internal termination network for a 50 ohm line impedance environment, shown in Figure 1. For further reference, see Application Note AND8020, Termination of ECL Logic Devices. Input considerations are required for D and  $\overline{D}$  under no signal conditions to prevent instability.

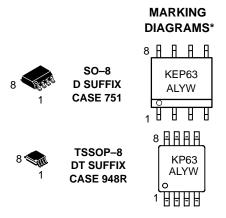
Special considerations are required for differential inputs under No Signal conditions to prevent instability.

- 220 ps Propagation Delay
- Maximum Frequency > 4 GHz Typical (See Graph)
- The 100 Series Contains Temperature Compensation
- PECL Mode Operating Range:  $V_{CC} = 3.0 \text{ V}$  to 5.5 V with  $V_{EE} = 0 \text{ V}$
- NECL Mode Operating Range: V<sub>CC</sub> = 0 V with  $V_{EE} = -3.0 \text{ V}$  to -5.5 V
- Open Input Default State
- 50 Ω Internal Termination Resistor



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K = MC100

A = Assembly Location

L = Wafer Lot

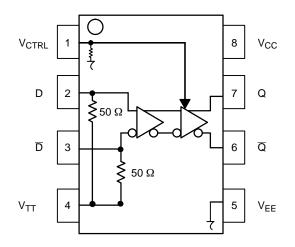
Y = Year

W = Work Week

#### ORDERING INFORMATION

Device	Package	Shipping
MC100EP16VTD	SO-8	98 Units/Rail
MC100EP16VTDR2	SO-8	2500 Tape & Reel
MC100EP16VTDT	TSSOP-8	100 Units/Rail
MC100EP16VTDTR2	TSSOP-8	2500 Tape & Reel

<sup>\*</sup>For additional information, see Application Note AND8002/D



## **PIN DESCRIPTION**

PIN	FUNCTION
D, $\overline{D}$	ECL Data Inputs
Q, Q	ECL Data Outputs
V <sub>CTRL</sub> *	Output Swing Control
V <sub>TT</sub>	Termination Supply
V <sub>CC</sub>	Positive Supply
V <sub>EE</sub>	Negative Supply

<sup>\*</sup> Pin will default LOW when left open.

Figure 1. 8-Lead Pinout (Top View) and Logic Diagram

## **ATTRIBUTES**

Chara	Value				
Internal Input Pulldown Resisto	75 kΩ				
Internal Input Pullup Resistor	N/A				
ESD Protection	Human Body Model Machine Model Charged Device Model	> 4 kV > 200 V > 2 kV			
Moisture Sensitivity, Indefinite	Time Out of Drypack (Note 1.)	Level 1			
Flammability Rating Oxygen Index	UL-94 code V-0 A 1/8" 28 to 34				
Transistor Count	140 Devices				
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test					

<sup>1.</sup> For additional information, see Application Note AND8003/D.

## MAXIMUM RATINGS (Note 2.)

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V <sub>CC</sub>	PECL Mode Power Supply	V <sub>EE</sub> = 0 V		6	V
V <sub>EE</sub>	NECL Mode Power Supply	V <sub>CC</sub> = 0 V		-6	V
Vi	PECL Mode Input Voltage NECL Mode Input Voltage	V <sub>EE</sub> = 0 V V <sub>CC</sub> = 0 V	$\begin{array}{c} V_{I} \leq V_{CC} \\ V_{I} \geq V_{EE} \end{array}$	6 6	V V
l <sub>out</sub>	Output Current	Continuous Surge		50 100	mA mA
TA	Operating Temperature Range			-40 to +85	°C
T <sub>stg</sub>	Storage Temperature Range			-65 to +150	°C
$\theta_{JA}$	Thermal Resistance (Junction to Ambient)	0 LFPM 500 LFPM	8 SOIC 8 SOIC	190 130	°C/W °C/W
$\theta_{\text{JC}}$	Thermal Resistance (Junction to Case)	std bd	8 SOIC	41 to 44	°C/W
$\theta_{JA}$	Thermal Resistance (Junction to Ambient)	0 LFPM 500 LFPM	8 TSSOP 8 TSSOP	185 140	°C/W °C/W
$\theta_{\text{JC}}$	Thermal Resistance (Junction to Case)	std bd	8 TSSOP	41 to 44 ± 5%	°C/W
T <sub>sol</sub>	Wave Solder	<2 to 3 sec @ 248°C		265	°C

<sup>2.</sup> Maximum Ratings are those values beyond which device damage may occur.

## DC CHARACTERISTICS, PECL $V_{CC} = 3.3 \text{ V}$ , $V_{EE} = 0 \text{ V}$ (Note 3.)

		–40°C		25°C			85°C				
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current	30	36	42	31	38	44	32	40	48	mA
V <sub>OH</sub>	$\begin{array}{ll} \text{Output HIGH Voltage (Max Swing)} \\ \text{(Note 4.)} & \text{$V_{\text{CC}} \geq V_{\text{CTRL}} \geq V_{\text{EE}}$} \end{array}$	2155		2405	2155		2405	2155		2405	mV
V <sub>OL</sub>	Output LOW Voltage (Max Swing) (Note 4.) $V_{CTRL} \leq V_{BB}$	1355	1490	1605	1355	1520	1605	1355	1520	1605	mV
	$V_{CC} \ge V_{CTRL} > V_{BB}$		See Fig.2			See Fig.2			See Fig.2		
	V <sub>CTRL</sub> = V <sub>CC</sub> (Min Swing)	2105	2230	2355	2095	2220	2345	2065	2190	2315	
$V_{IH}$	D, D Input HIGH Voltage (Single Ended)	2075		2420	2075		2420	2075		2420	mV
$V_{IL}$	D, D Input LOW Voltage (Single Ended)	1490		1675	1490		1675	1490		1675	mV
V <sub>CTRL</sub>	Input Voltage (V <sub>CTRL</sub> )	V <sub>EE</sub>		V <sub>CC</sub>	V <sub>EE</sub>		V <sub>CC</sub>	V <sub>EE</sub>		V <sub>CC</sub>	mV
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Differential) (Note 5.)	2.0		2.9	2.0		2.9	2.0		2.9	V
I <sub>IH</sub>	Input HIGH Current (V <sub>TT</sub> Open)			150			150			150	μΑ
I <sub>IL</sub>	Input LOW Current (V <sub>TT</sub> Open)	-150			-150			-150			μΑ

NOTE: EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfpm is maintained.

- Input and output parameters vary 1:1 with V<sub>CC</sub>. V<sub>EE</sub> can vary +0.3 V to -2.2 V.
   All loading with 50 ohms to V<sub>CC</sub>-2.0 volts. V<sub>OH</sub> does not change with V<sub>CTRL</sub>. V<sub>OL</sub> changes with V<sub>CTRL</sub>. V<sub>CTRL</sub> is referenced to V<sub>CC</sub>.
   V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

### DC CHARACTERISTICS, PECL V<sub>CC</sub> = 5.0 V, V<sub>EE</sub> = 0 V (Note 6.)

		-40°C		25°C			85°C				
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current	30	36	42	31	38	44	32	40	48	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 7.)  VCC > VCTRL > VEE	3855	3980	4105	3855	3980	4105	3855	3980	4105	mV
V <sub>OL</sub>	Output LOW Voltage (Max Swing) (Note 7.) $V_{CTRL} \leq V_{BB}$	3055	3190	3305	3055	3220	3305	3055	3220	3305	mV
	$VCC \ge V_{CTRL} > V_{BB}$		See Fig.2			See Fig.2			See Fig.2		
	V <sub>CTRL</sub> = V <sub>CC</sub> (Min Swing)	3805	3930	4055	3795	3920	4045	3765	3890	4015	
V <sub>IH</sub>	D, D Input HIGH Voltage (Single Ended)	3775		4120	3775		4120	3775		4120	mV
V <sub>IL</sub>	D, D Input LOW Voltage (Single Ended)	3190		3375	3190		3375	3190		3375	mV
V <sub>CTRL</sub>	Input Voltage (V <sub>CTRL</sub> )	V <sub>EE</sub>		$V_{CC}$	V <sub>EE</sub>		$V_{CC}$	V <sub>EE</sub>		$V_{CC}$	mV
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Differential) (Note 8.)	2.0		4.6	2.0		4.6	2.0		4.6	V
I <sub>IH</sub>	Input HIGH Current (V <sub>TT</sub> Open)			150			150			150	μΑ
I <sub>IL</sub>	Input LOW Current (V <sub>TT</sub> Open)	-150			-150			-150			μΑ

NOTE: EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfpm is maintained.

- Input and output parameters vary 1:1 with V<sub>CC</sub>. V<sub>EE</sub> can vary +2.0 V to -0.5 V.
   All loading with 50 ohms to V<sub>CC</sub>-2.0 volts. V<sub>OH</sub> does not change with V<sub>CTRL</sub>. V<sub>OL</sub> changes with V<sub>CTRL</sub> is referenced to V<sub>CC</sub>.
- 8. V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

DC CHARACTERISTICS, NECL  $V_{CC} = 0 \text{ V}$ ;  $V_{EE} = -5.5 \text{ V}$  to -3.0 V (Note 9.)

		–40°C		25°C			85°C				
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	Power Supply Current	30	36	42	31	38	44	32	40	48	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 10.) V <sub>CC</sub> > V <sub>CTRL</sub> > V <sub>EE</sub>	-1145	-1020	-895	-1145	-1020	-895	-1145	-1020	-895	mV
V <sub>OL</sub>		-1945	-1810	-1695	-1945	-1780	-1695	-1945	-1780	-1695	mV
	$VCC \ge V_{CTRL} > V_{BB}$		See Fig.2			See Fig.2			See Fig.2		
	V <sub>CTRL</sub> = V <sub>CC</sub> (Min Swing)	-1195	-1070	-945	-1205	-1080	-955	-1235	-1110	-985	
V <sub>IH</sub>	D, D Input HIGH Voltage (Single Ended)	-1225		-880	-1225		-880	-1225		-880	mV
V <sub>IL</sub>	D, D Input LOW Voltage (Single Ended)	-1810		-1625	-1810		-1625	-1810		-1625	mV
V <sub>CTRL</sub>	Input Voltage (V <sub>CTRL</sub> )	V <sub>EE</sub>		V <sub>CC</sub>	V <sub>EE</sub>		V <sub>CC</sub>	V <sub>EE</sub>		V <sub>CC</sub>	mV
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Differential) (Note 11.)	V <sub>EE</sub>	+2.0	-0.4	V <sub>EE</sub>	+2.0	-0.4	V <sub>EE</sub>	+2.0	-0.4	V
I <sub>IH</sub>	Input HIGH Current (V <sub>TT</sub> Open)			150			150			150	μΑ
I <sub>IL</sub>	Input LOW Current (V <sub>TT</sub> Open)	-150			-150			-150			μΑ

NOTE: EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500 lfpm is maintained.

## AC CHARACTERISTICS $V_{CC} = 0 \text{ V}$ ; $V_{EE} = -3.0 \text{ V}$ to -5.5 V or $V_{CC} = 3.0 \text{ V}$ to 5.5 V; $V_{EE} = 0 \text{ V}$ (Note 12.)

			-40°C		25°C			85°C			
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f <sub>max</sub>	Maximum Toggle Frequency (See Figure 8. F <sub>max</sub> /JITTER)		> 4			> 4			> 4		GHz
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay to Output Differential Max Swing Min Swing	250 200	300 250	350 300	250 200	300 250	350 300	250 200	300 250	350 300	ps
t <sub>SKEW</sub>	Duty Cycle Skew (Note 13.)		5.0	20		5.0	20		5.0	20	ps
t <sub>JITTER</sub>	Cycle-to-Cycle Jitter (See Figure 8. F <sub>max</sub> /JITTER)		0.2	< 1		0.2	< 1		0.2	< 1	ps
V <sub>PP</sub>	Input Voltage Swing (Differential) (Note 14.)	150	800	1200	150	800	1200	150	800	1200	mV
t <sub>r</sub> , t <sub>f</sub>	Output Rise/Fall Times Max Swing Q (20% – 80%) Min Swing	70 30	120 80	170 130	80 20	130 70	180 120	100 20	150 70	200 120	ps

<sup>12.</sup> Measured using a 750 mV source, 50% duty cycle clock source. All loading with 50 ohms to  $V_{CC}$ -2.0 V.

<sup>9.</sup> Input and output parameters vary 1:1 with V<sub>CC</sub>.

10. All loading with 50 ohms to V<sub>CC</sub>–2.0 volts. V<sub>OH</sub> does not change with V<sub>CTRL</sub>. V<sub>OL</sub> changes with V<sub>CTRL</sub>. V<sub>CTRL</sub> is referenced to V<sub>CC</sub>.

11. V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

<sup>13.</sup> Skew is measured between outputs under identical transitions. Duty cycle skew is defined only for differential operation when the delays are measured from the cross point of the inputs to the cross point of the outputs.

<sup>14.</sup> V<sub>PP</sub>(min) is minimum input swing for which AC parameters are guaranteed.

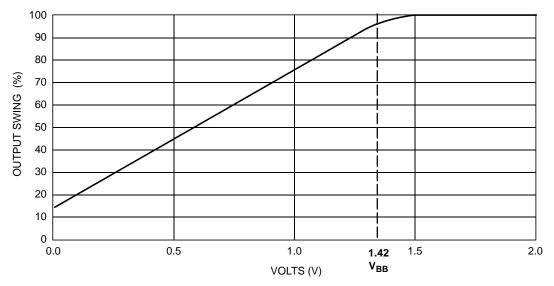


Figure 2. V<sub>CC</sub> – V<sub>CTRL</sub> (pin #1)

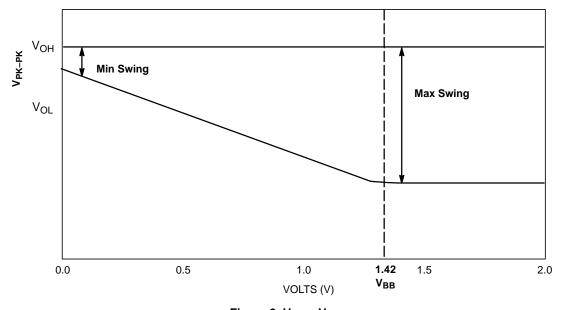


Figure 3. V<sub>CC</sub> - V<sub>CTRL</sub>

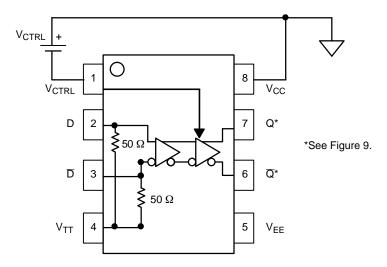


Figure 4. Voltage Source Implementation,  $V_{CTRL}$  Pin 1

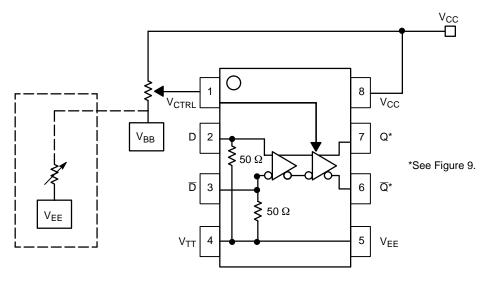


Figure 5. Alternative Implementations,  $V_{CTRL}$  Pin 1

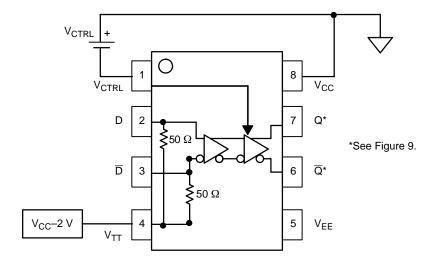


Figure 6. Standard Termination Method,  $V_{TT}$  Pin 4

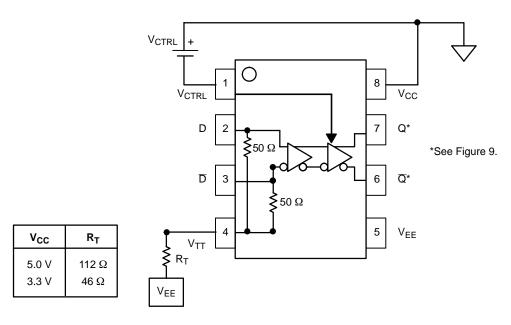


Figure 7. Alternate "Y" Termination Method,  $V_{TT}$  Pin 4

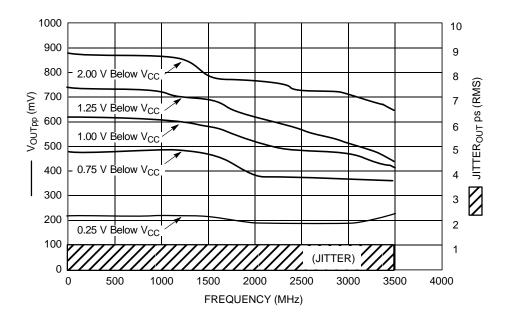


Figure 8. F<sub>max</sub>/Jitter

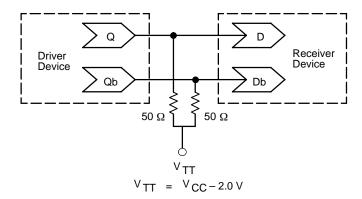


Figure 9. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020 – Termination of ECL Logic Devices.)

## **Resource Reference of Application Notes**

AN1404 – ECLinPS Circuit Performance at Non–Standard V<sub>IH</sub> Levels

AN1405 – ECL Clock Distribution Techniques

AN1406 – Designing with PECL (ECL at +5.0 V)

AN1504 – Metastability and the ECLinPS Family

AN1568 - Interfacing Between LVDS and ECL

AN1650 – Using Wire-OR Ties in ECLinPS Designs

AN1672 - The ECL Translator Guide

AND8001 – Odd Number Counters Design

AND8002 - Marking and Date Codes

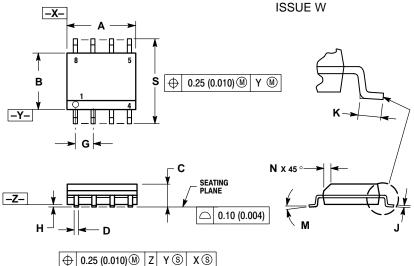
AND8009 - ECLinPS Plus Spice I/O Model Kit

AND8020 - Termination of ECL Logic Devices

For an updated list of Application Notes, please see our website at http://onsemi.com.

#### PACKAGE DIMENSIONS

## SO-8 **D SUFFIX** PLASTIC SOIC PACKAGE CASE 751-07



#### NOTES:

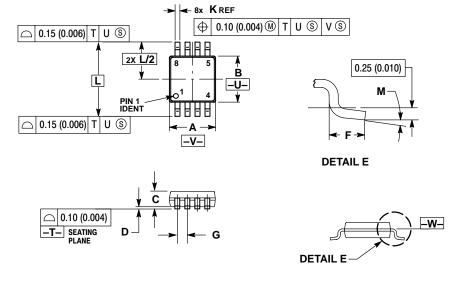
- DIMENSIONING AND TOLERANCING PER ANSI
  Y14.5M. 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSION A AND B DO NOT INCLUDE MOLD
- PROTRUSION.

  MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER
- SIDE.

  DIMENSION D DOES NOT INCLUDE DAMBAR
  PROTRUSION. ALLOWABLE DAMBAR
  PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN
  EXCESS OF THE D DIMENSION AT MAXIMUM
  MATERIAL CONDITION.

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	4.80	5.00	0.189	0.197
В	3.80	4.00	0.150	0.157
С	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27	7 BSC	0.05	0 BSC
Н	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
М	0 °	8 °	0 °	8 °
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

## TSSOP-8 **DT SUFFIX** PLASTIC TSSOP PACKAGE CASE 948R-02 ISSUE A



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSION A DOES NOT INCLUDE MOLD FLASH.
  PROTRUSIONS OR GATE BURRS. MOLD FLASH
  OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.

  4. DIMENSION B DOES NOT INCLUDE INTERLEAD
- FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.

  5. TERMINAL NUMBERS ARE SHOWN FOR
- REFERENCE ONLY.

  6. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	2.90	3.10	0.114	0.122
В	2.90	3.10	0.114	0.122
С	0.80	1.10	0.031	0.043
D	0.05	0.15	0.002	0.006
F	0.40	0.70	0.016	0.028
G	0.65	BSC	0.026	BSC
K	0.25	0.40	0.010	0.016
L	4.90	BSC	0.193	BSC
M	0°	6 °	0°	6°





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